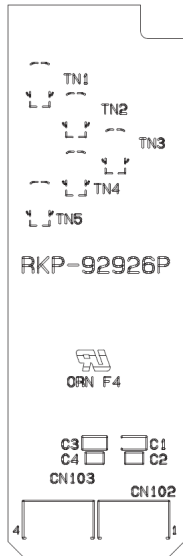
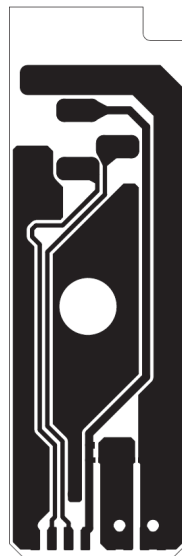


SILK PRINT FOR PARTS SIDE



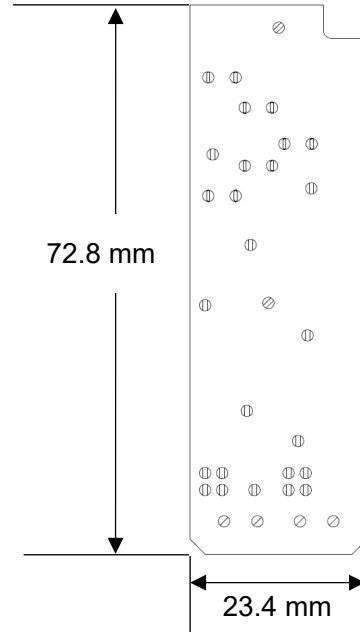
PARTS SIDE



SOLDERING SIDE



THROUGH HOLE FOR PARTS SIDE



MARK	DIAGRAM	HOLE	MEMO
⊙	φ 1.0	TH	
⊙	φ 0.4×1.4	TH	
⊘	φ 0.65	NTH	
⊘	φ 3.8	NTH	

All drawings are view of parts side  
SCALE 1:1

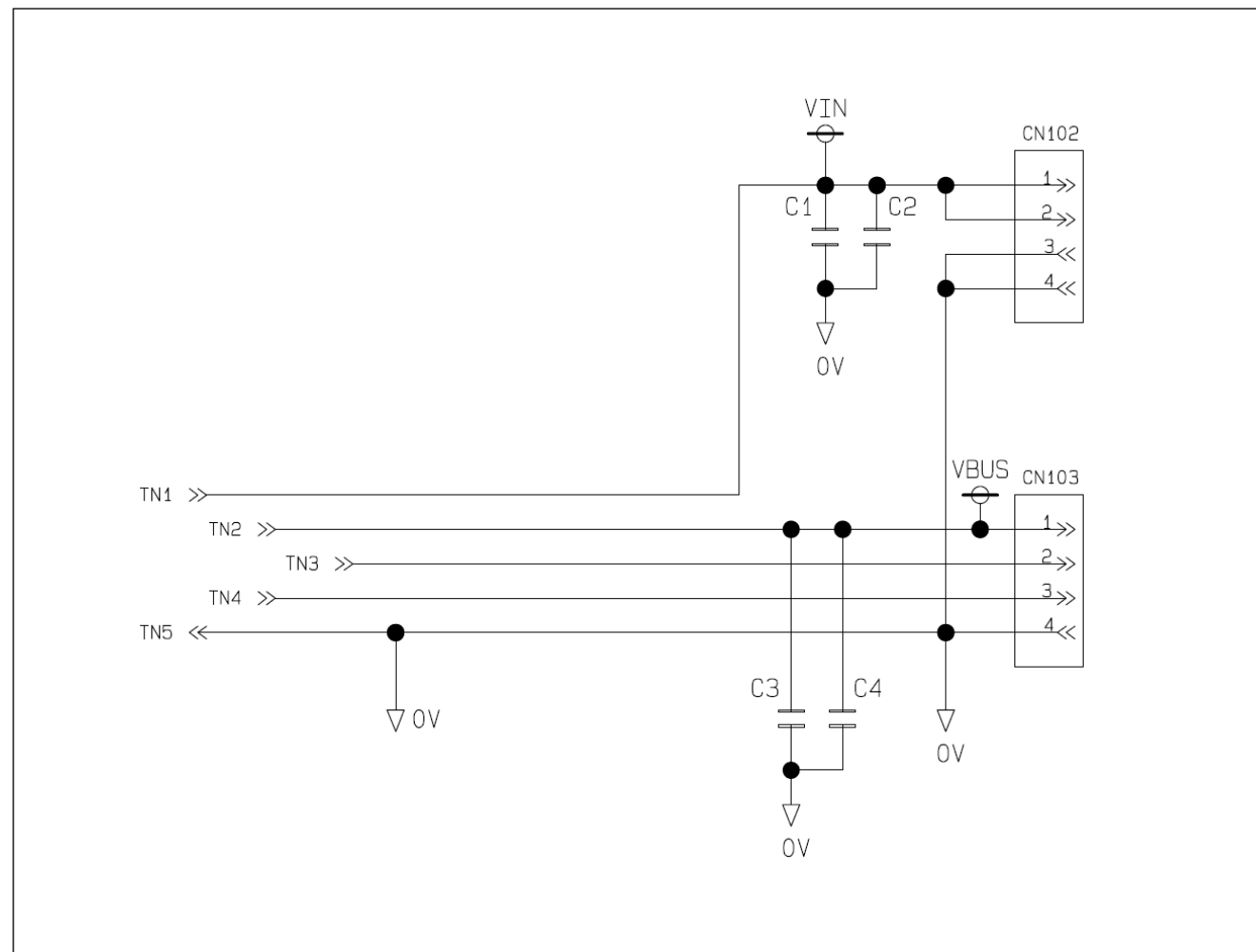
SPECIFICATION FOR PCB

- PCB No. : RKP-92926P
- Material : Glass epoxy
- Thickness : 1.6mm
- Layer number : 2
- Thickness copper film : 35um
- Copper thickness of the via's : 35um above.
- Minimum conductor width : 0.3mm
- CTI : 100 above

PARTS LIST

Mark of drawing	Kind of parts	Rating / Model of parts	Remarks
C1,C2,C3,C4	Chip multilayer capacitor	Total capacitance 5.33uFmax	

All components may be replaced with equivalent components or may not be mounted.



SCHEMATIC

注 記 NOTES		改版担当者 REV. BY	改版日 REVISED	名 称 NAME INNER CHARGL PCB EAGLE3
改版回数 REV. 0	総頁数 PAGES 1			
承 認 APPROVED 山田和則	検 討 CHECKED 小野圭	製 図 DRAWN 木村司	作成日 DATE 2024.2.21	図 番 DWG. NO. E 3 - 6 9 9 1 - 6 5 2 5 - 9 0 - 0 1 A